



Product Change Notification

107111 - 02

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Product Change Notification

Change Notification #: 107111 - 02
Change Title: Intel® 4/2/1Gbps Small Form Factor (SFF) Optical Transceiver, PCN 107111-02, Product Material, TXN31015D00000, TXN31015D100002, TOSA Supply, PCB Supply and Label Changes, Reason for Revision: to Remove the ROSA Supply Changes
Date of Publication: January 17, 2007

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date of Samples Availability:	Jan 15, 2007
Date of Qualification Data Availability:	Apr 22, 2007
Date Customer Must be Ready to Receive Post-Conversion Material:	Apr 22, 2007

Description of Change to the Customer:

Reason for Revision: to Remove the ROSA Supply Changes

1. TOSA Supply Changes

One of the VCSEL TOSA suppliers has moved their VCSEL epi reactor, wafer fab and production line from Richardson, Texas to Allen, Texas. Intel is conducting the 2,000-hour module-level qualification test, and the result will be available in April, 2007.

2. PCB Supply Changes

A second PCB source will be added to the supply. There will be no design change on the PCB. New PCB has passed Intel's board-level and module-level reliability testing.

3. Product Label Changes

The serial number barcode will be incorporated into the product label placed on top of the module. The standalone barcode label will be removed from the side of the module. The "Intel" logo on the product label will also be updated to reflect the new Intel Corporation logo.

Customer Impact of Change and Recommended Action:

Customer may request samples incorporated with new materials and changes for qualification. Intel will start shipping units with described changes starting April 22, 2007.

There will be no part number or MM number change.

Products Affected / Intel Ordering Codes:

Affected Product Code	Affected MM#
TXN31015D000000	862941
TXN31015D100002	876782
TXN31015D100000	869477

Reference Documents / Attachments:

Document:

Location #:

PCN Revision History:

Date of Revision:

Revision Number:

Reason:

December 22, 2006

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Originally Published PCN

January 4, 2007

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to add additional affected order code

January 17, 2007

02

to Remove the ROSA Supply Changes